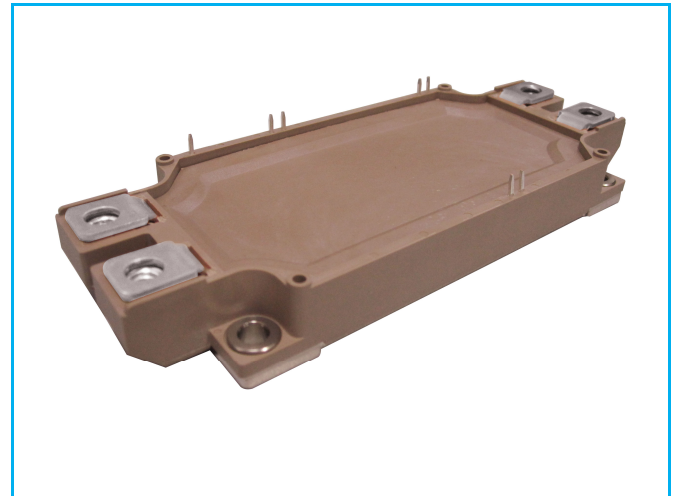


PRODUCT FEATURES

- IGBT³ CHIP(Trench+Field Stop technology)
- High short circuit capability,self limiting short circuit current
- $V_{CE(sat)}$ with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Temperature sense included



APPLICATIONS

- AC motor control
- Motion/servo control
- Inverter and power supplies
- Photovoltaic/Fuel cell

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS($T_C=25^{\circ}C$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J=25^{\circ}C$	V
V_{GES}	Gate Emitter Voltage		
I_C	DC Collector Current	$T_C=25^{\circ}C, T_{Jmax}=175^{\circ}C$	A
		$T_C=50^{\circ}C, T_{Jmax}=175^{\circ}C$	
I_{CM}	Repetitive Peak Collector Current	$t_p=1ms$	
P_{tot}	Power Dissipation Per IGBT	$T_C=25^{\circ}C, T_{Jmax}=175^{\circ}C$	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS ($T_C=25^{\circ}C$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^{\circ}C$	V
$I_{F(AV)}$	Average Forward Current		A
I_{FRM}	Repetitive Peak Forward Current	$t_p=1ms$	
I^2t		$T_J=125^{\circ}C, t=10ms, V_R=0V$	A ² S

MacMic Science & Technology Co., Ltd.

Add: #18, Hua Shan Zhong Lu, New District, Changzhou City, Jiangsu Province, P. R .of China

MMG450WB065B6EN

IGBT-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit	
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=7.2\text{mA}$	4.9	5.8	6.5	V	
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=450\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.45	1.9		
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		1.6			
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_J=150^\circ\text{C}$		1.7			
I_{CES}	Collector Leakage Current	$V_{CE}=650\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			3	mA	
		$V_{CE}=650\text{V}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$			15	mA	
I_{GES}	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 15\text{V}, T_J=25^\circ\text{C}$	-500		500	nA	
Q_g	Gate Charge	$V_{CE}=300\text{V}, I_C=450\text{A}, V_{GE}=\pm 15\text{V}$		3		μC	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		30		nF	
C_{res}	Reverse Transfer Capacitance				0.9		nF
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=300\text{V}, I_C=450\text{A}$ $R_G=1.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		280		ns
			$T_J=150^\circ\text{C}$		300		ns
t_r	Rise Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		100		ns
			$T_J=150^\circ\text{C}$		110		ns
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=300\text{V}, I_C=450\text{A}$ $R_G=1.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		450		ns
			$T_J=150^\circ\text{C}$		500		ns
t_f	Fall Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		70		ns
			$T_J=150^\circ\text{C}$		90		ns
E_{on}	Turn on Energy	$V_{CC}=300\text{V}, I_C=450\text{A}$ $R_G=1.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		3.5		mJ
			$T_J=150^\circ\text{C}$		5.5		mJ
E_{off}	Turn off Energy	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		14.5		mJ
			$T_J=150^\circ\text{C}$		18		mJ
I_{SC}	Short Circuit Current	$t_{psc}\leq 6\mu\text{S}, V_{GE}=15\text{V}$ $T_J=150^\circ\text{C}, V_{CC}=360\text{V}$		2250		A	
R_{thJC}	Junction to Case Thermal Resistance (Per IGBT)				0.12	K/W	

Diode-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	$I_F=450\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.55	1.95	V
		$I_F=450\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.50		
		$I_F=450\text{A}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$		1.45		
t_{rr}	Reverse Recovery Time	$I_F=450\text{A}, V_R=300\text{V}$ $dI_F/dt=-4000\text{A}/\mu\text{s}$ $T_J=150^\circ\text{C}$		450		ns
I_{RRM}	Max. Reverse Recovery Current			120		A
Q_{RR}	Reverse Recovery Charge			35		μC
E_{rec}	Reverse Recovery Energy			10.5		mJ
R_{thJCD}	Junction to Case Thermal Resistance (Per Diode)				0.19	K/W

MMG450WB065B6EN

NTC CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Resistance $T_C=25^\circ\text{C}$		5		K Ω
$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15 \text{ K}))]$		3375		K

MODULE CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit	
T_{Jmax}	Max. Junction Temperature	175	°C	
T_{Jop}	Operating Temperature	-40~150		
T_{stg}	Storage Temperature	-40~125		
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
CTI	Comparative Tracking Index		> 225	
Torque	to heatsink	Recommended (M5)	2.5~5	Nm
	to terminal	Recommended (M6)	3~5	Nm
Weight			350	g

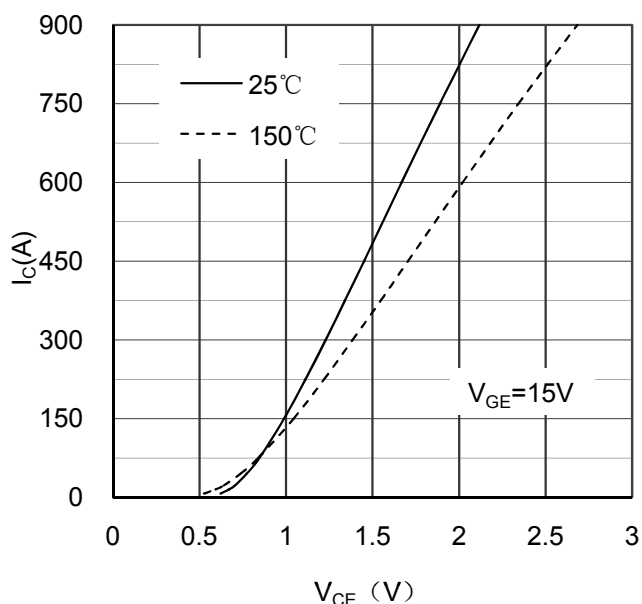


Figure 1. Typical Output Characteristics IGBT-inverter

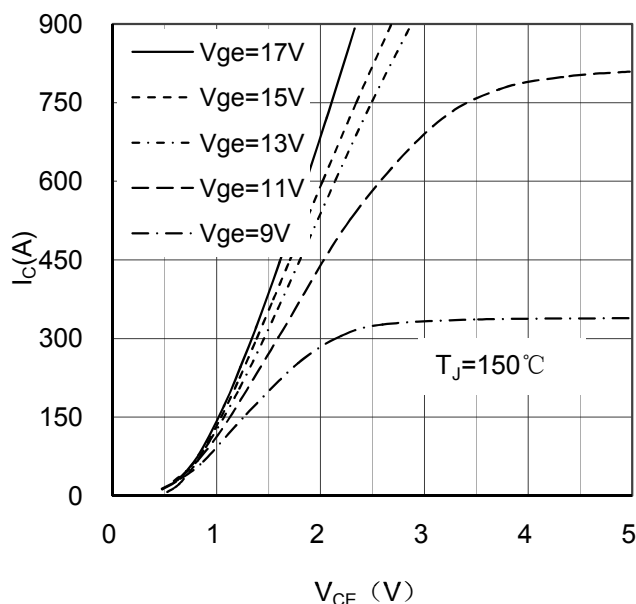


Figure 2. Typical Output Characteristics IGBT-inverter

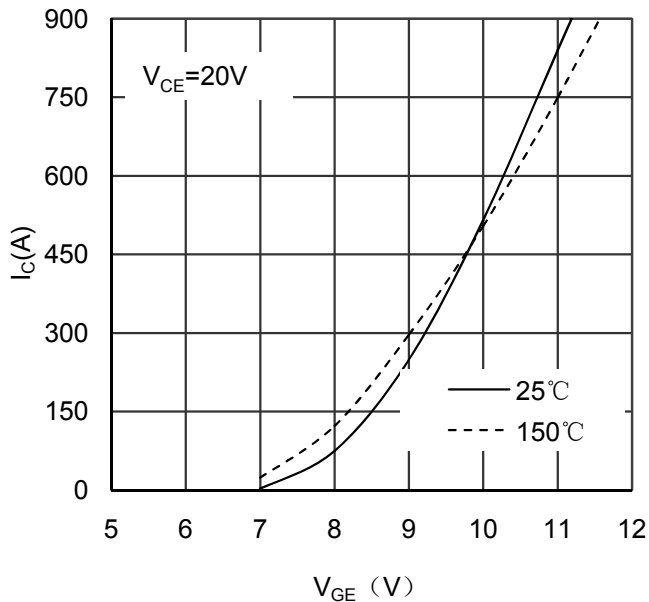


Figure 3. Typical Transfer characteristics IGBT-inverter

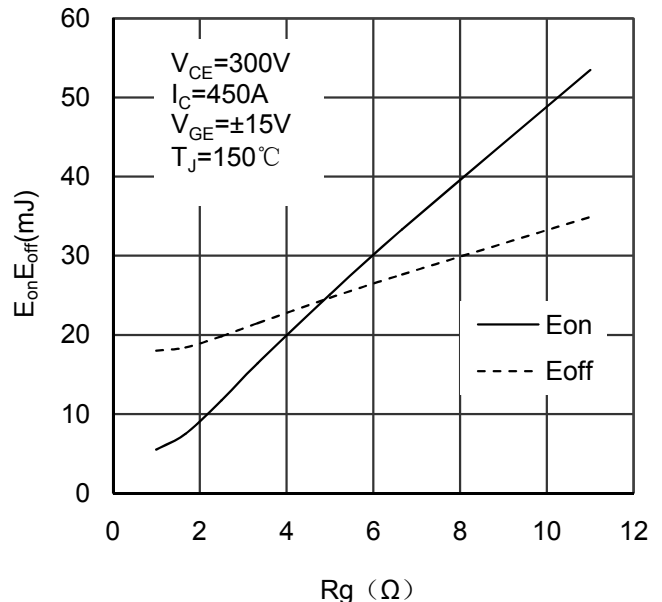


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

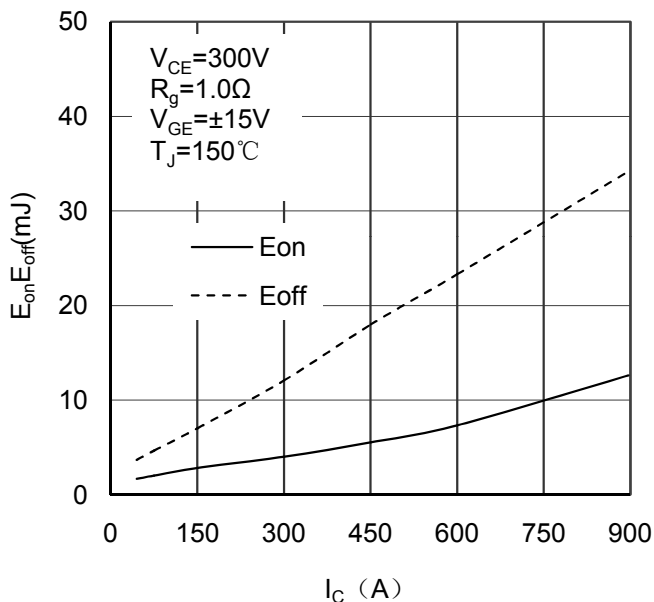


Figure 5. Switching Energy vs Collector Current IGBT-inverter

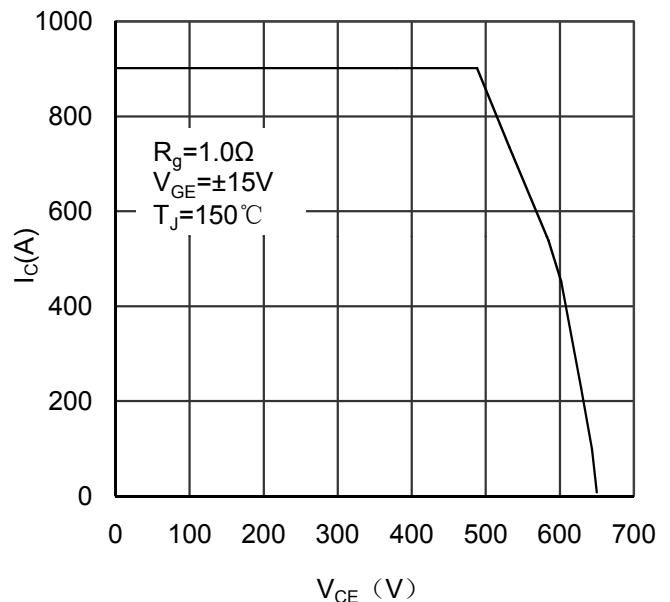


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

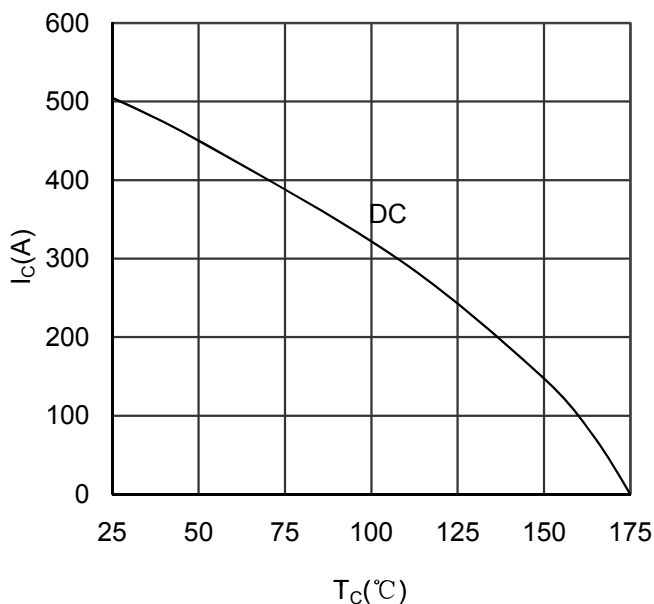


Figure 7. Collector Current vs Case temperature IGBT-inverter

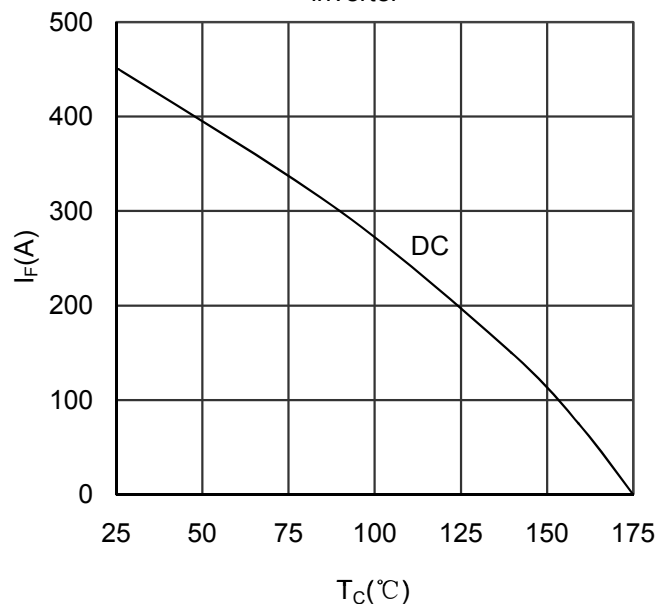


Figure 8. Forward current vs Case temperature Diode-inverter

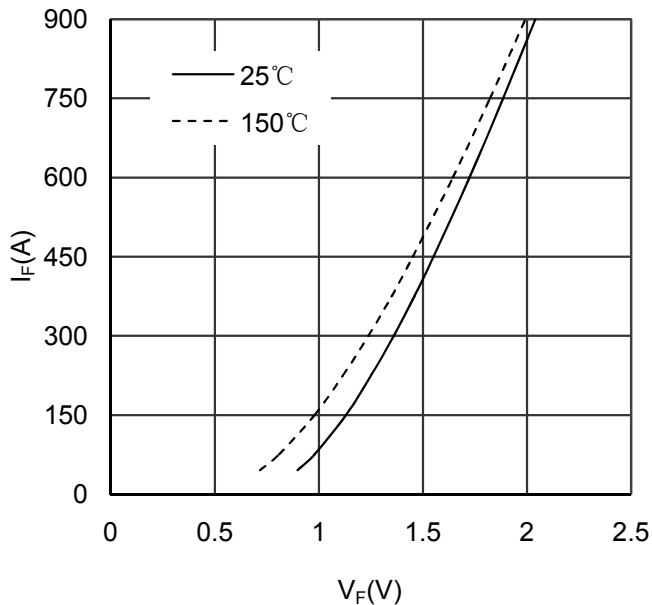


Figure 9. Diode Forward Characteristics Diode -inverter

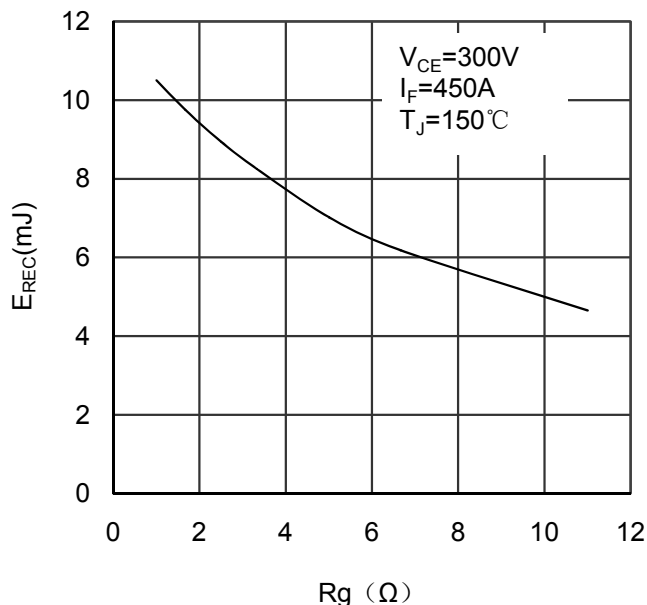


Figure 10. Switching Energy vs Gate Resistor Diode -inverter

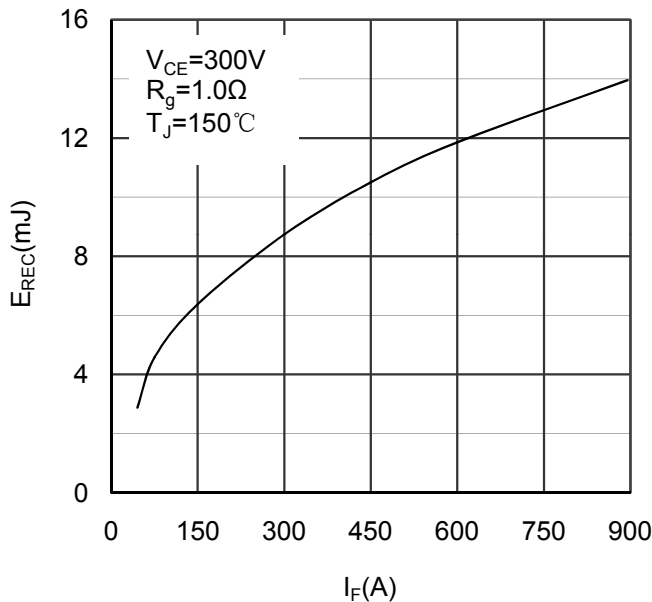


Figure 11. Switching Energy vs Forward Current Diode-inverter

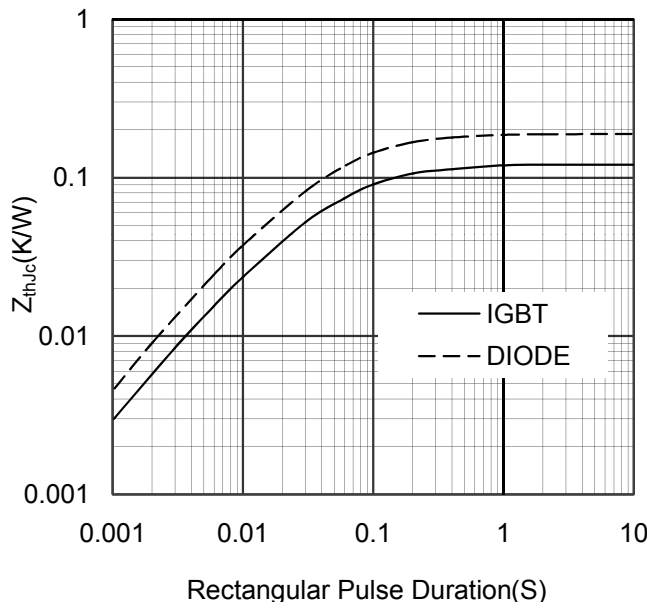


Figure 12. Transient Thermal Impedance of Diode and IGBT-inverter

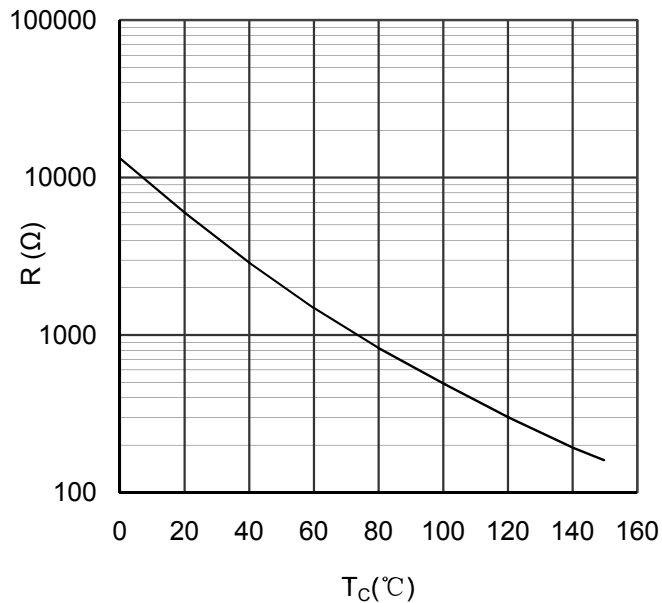


Figure 13. NTC Characteristics

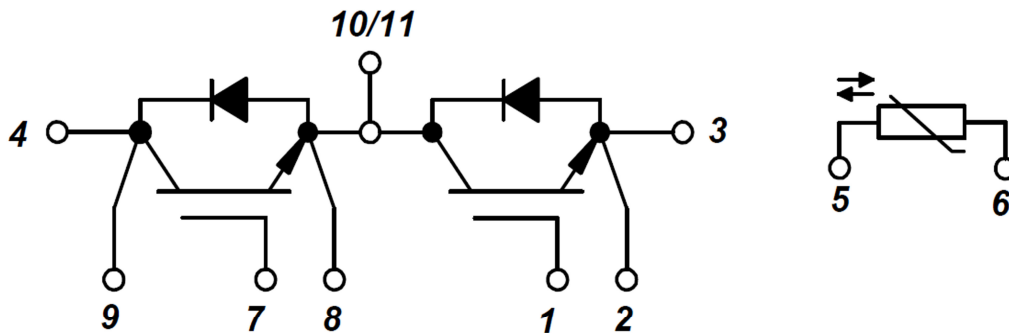
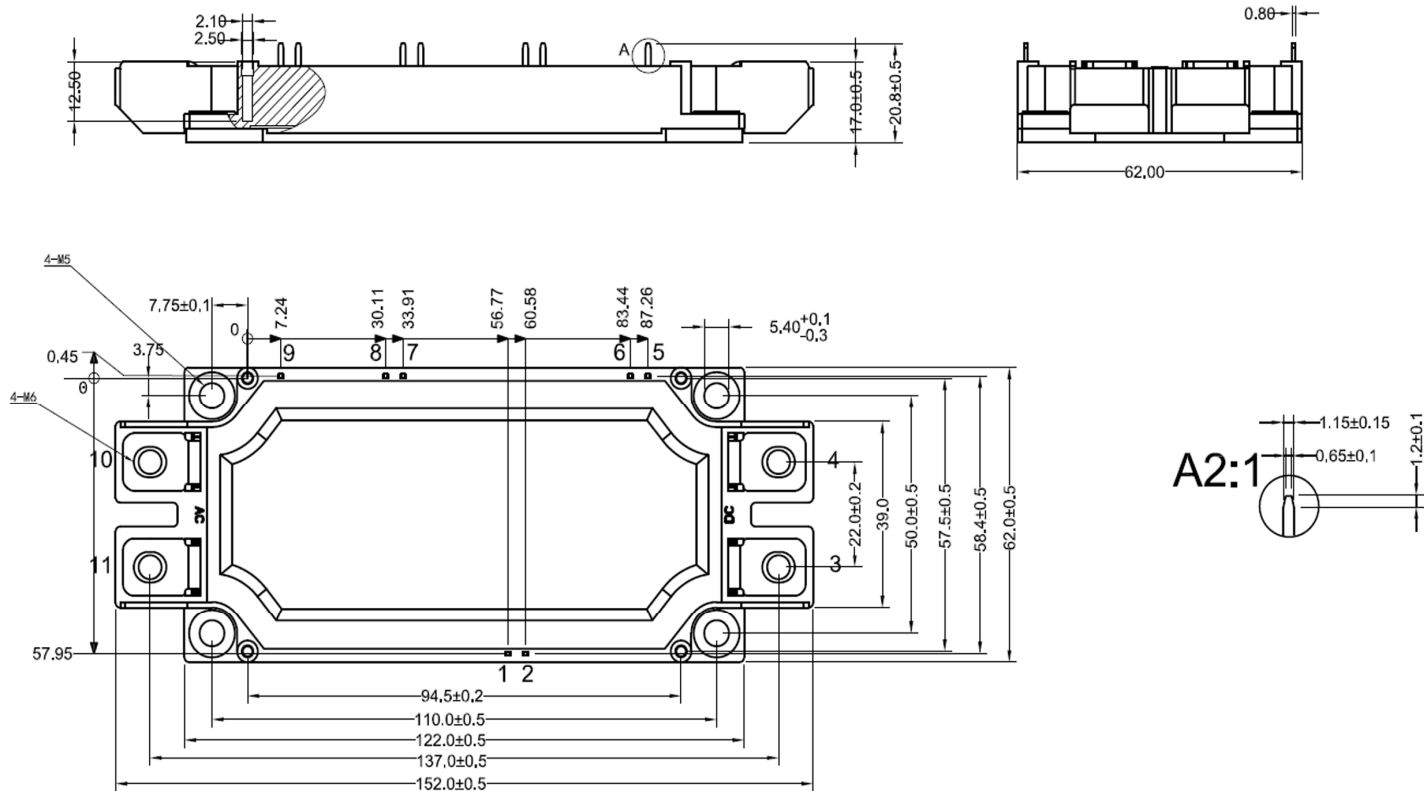


Figure 14. Circuit Diagram



Dimensions in (mm)

Figure 15. Package Outline